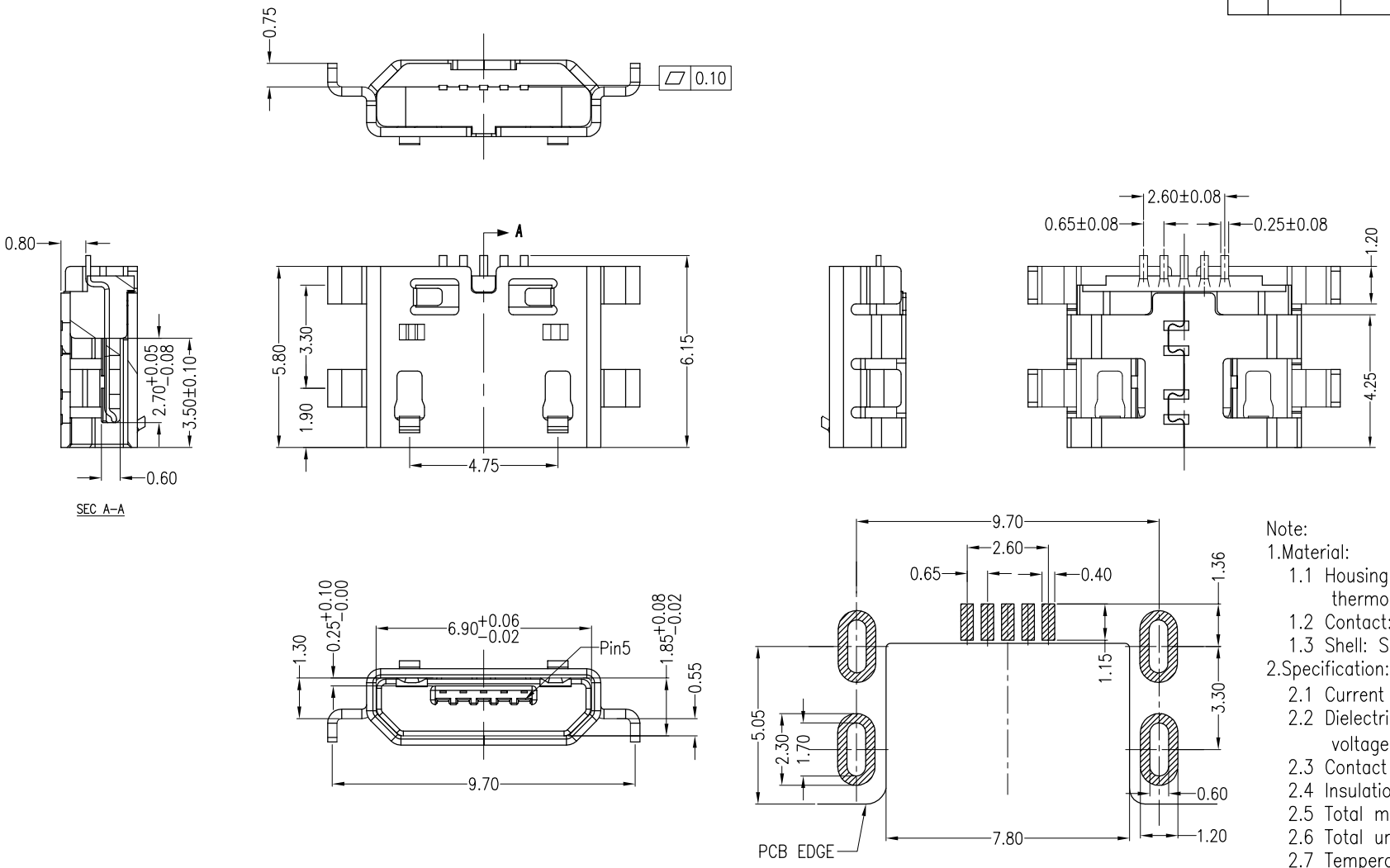
REV.	ECN NO	LOCATIONS	DESCRIPTION	DATE



RECOMMANDED PCB LAYOUT

PCB图仅供参考

Note:

1.Material:
- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
- 1.2 Contact: copper alloy,t=0.15mm
- 1.3 Shell: SUS304,t=0.30mm

2.Specification:
- 2.1 Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 30 mΩ Max.
- 2.4 Insulation resistance: 100 MΩ Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min.
- 2.7 Temperature range: -30°C~80°C

外壳材质
7:SUS304R-1/2H

外壳电镀
1:N50u''
2:雾T50u''
3:N+Au1u''(脚)
4:Au1u''

端子电镀 01:Au1u'';02:Au1.5u'';03:Au3u''
05:Au5u'' ;10:Au10u'';15:Au15u'';30:Au30u''

主体颜色 B:黑色

主体材质 1:LCP

端子材质 4:C5191R-EH

PART NO: USB-F06505-CB045		MATERAL: SEE NOTE	深圳市旺富达电子有限公司 WFDCONN SHEN ZHEN WFD ELECTRONICS CO., LTD
MODEL NO: XX		FINSH: SEE NOTE	
UNIT: MM	SIZE: A4	COLOR: SEE NOTE	TITLE: Micro usb 5s B Type Smt沉板0.8四脚全插无导位无孔 双卡点0.3版
TOLERANCE UNSPECIFIED .x 0.15 .xx 0.10 .xxx 0.05 Ang. 1°		DR: LIU MIAO	DWG NO: A562 REV: A
		CHK: SIMON	SCALE: 5:1 DATE: 2014.04.15
		APP: DAVID	